

Indian Institute of Technology Bombay



# Silicon Solar Cell Research Activities at NCPRE



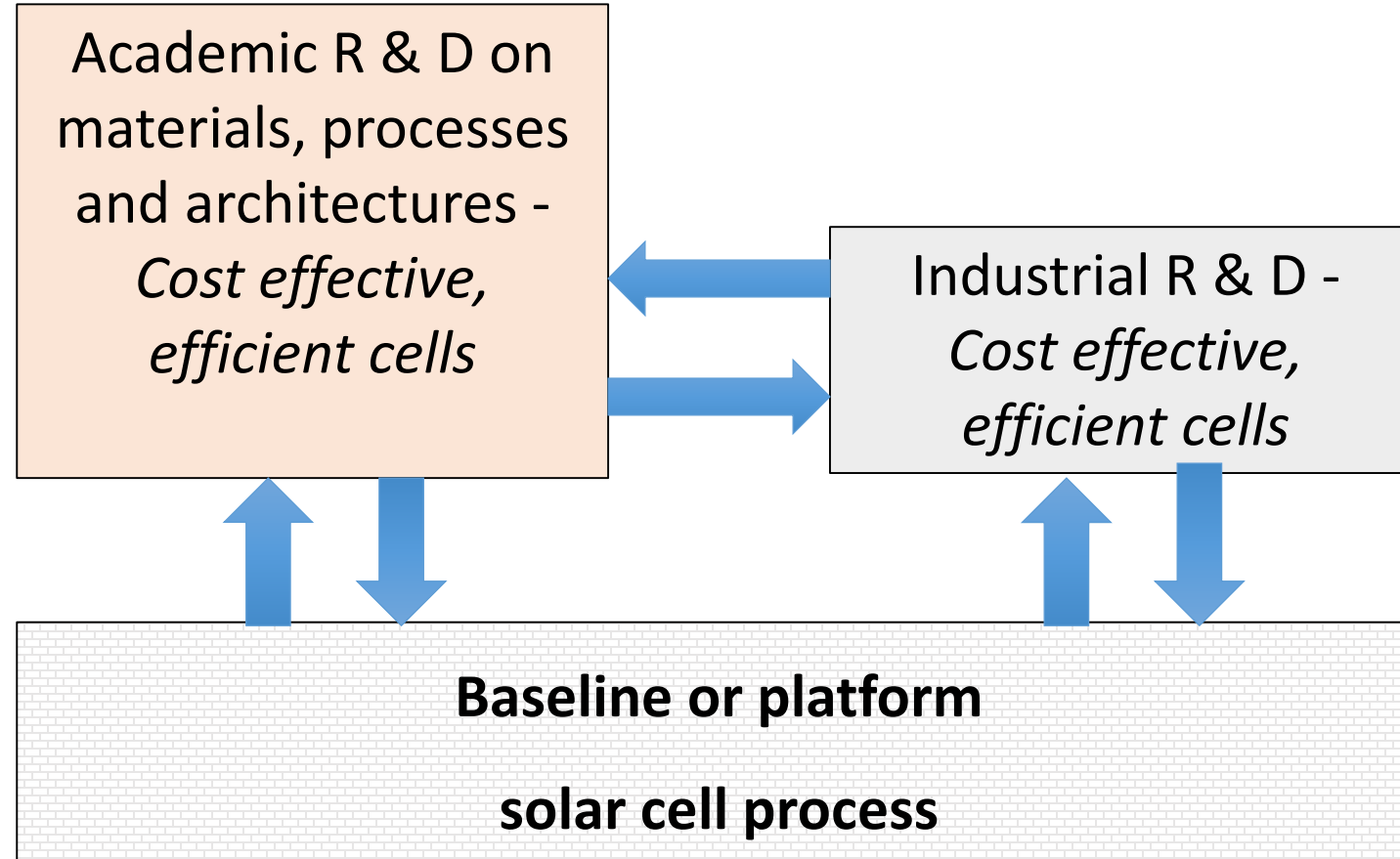
**NCPRE**

NATIONAL CENTRE FOR PHOTOVOLTAIC RESEARCH AND EDUCATION (NCPRE)

राष्ट्रीय प्रकाश वोल्टोय अनुसंधान एवं शिक्षा केन्द्र

-Supported by Ministry of New and Renewable Energy, Government of India

## c-Si research objectives @ NCPRE



# NCPRE Fabrication Lab

*Fabrication Lab Corridor*



*Clean Room*



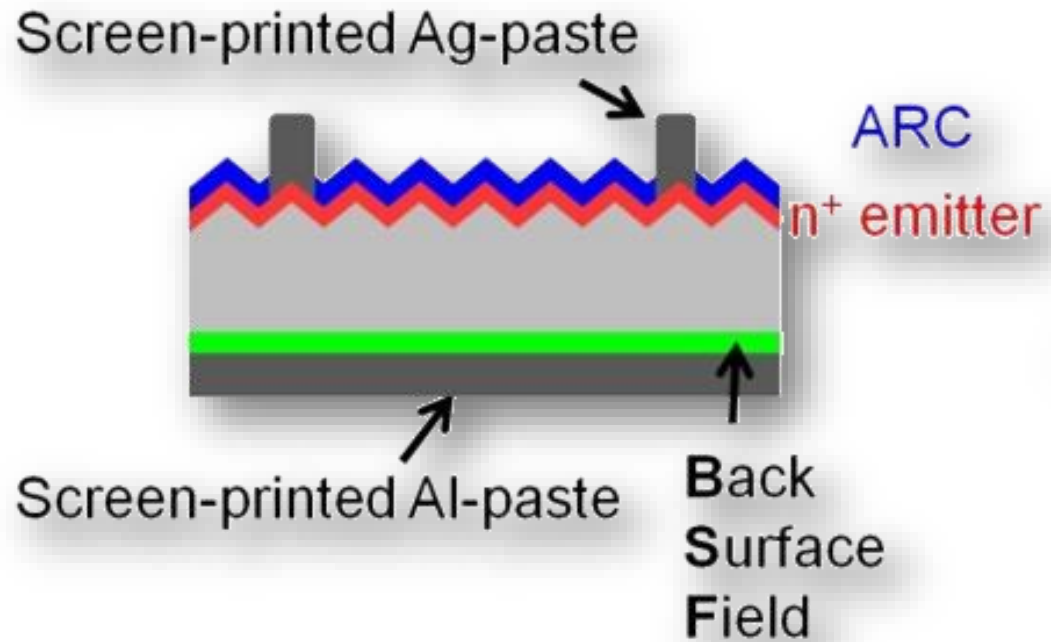
# NCPRE Opto-electrical Characterization Lab



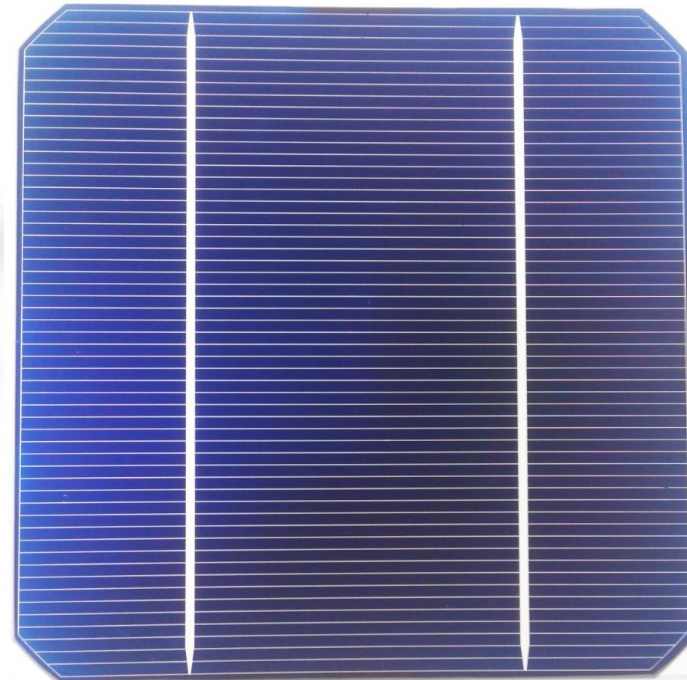


# Solar Cells made at NCPRE

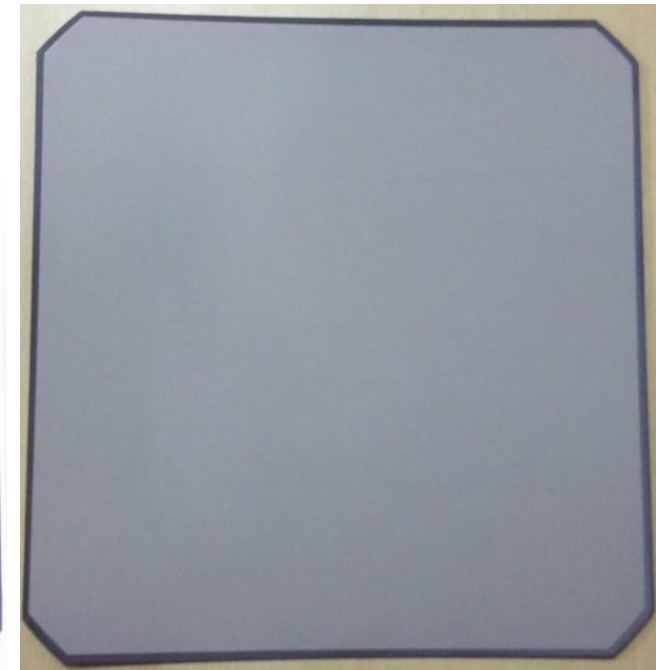
## Structure of Al-BSF solar Cell



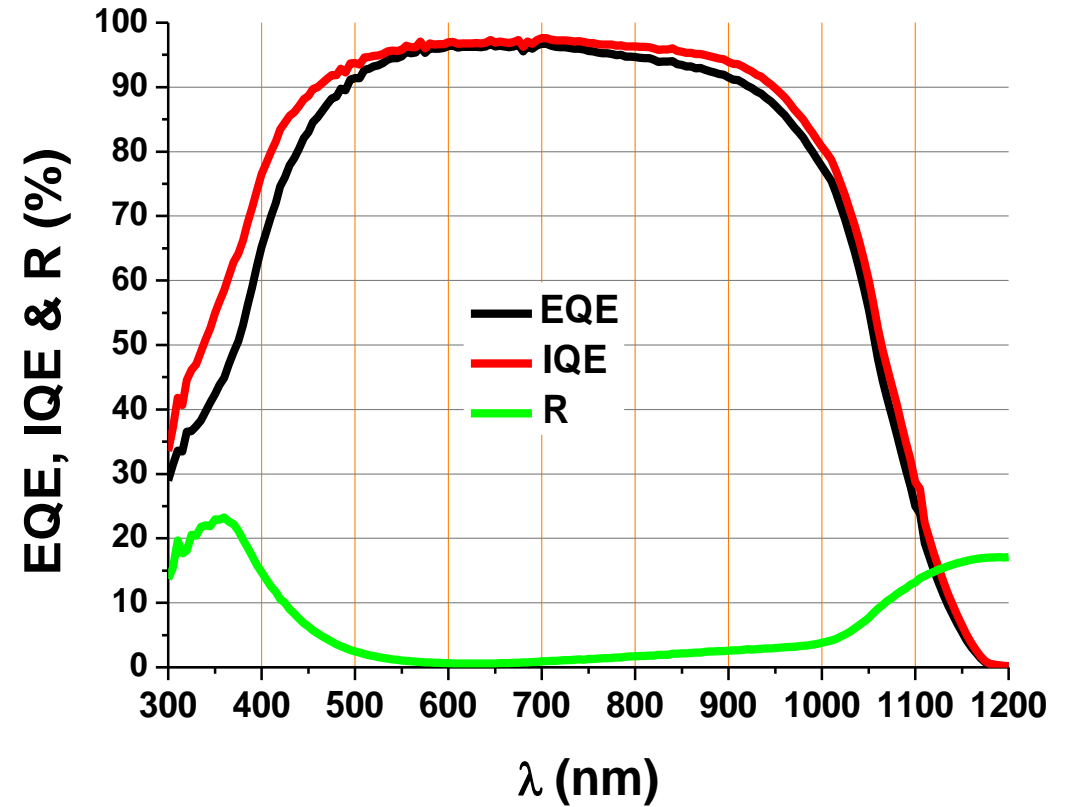
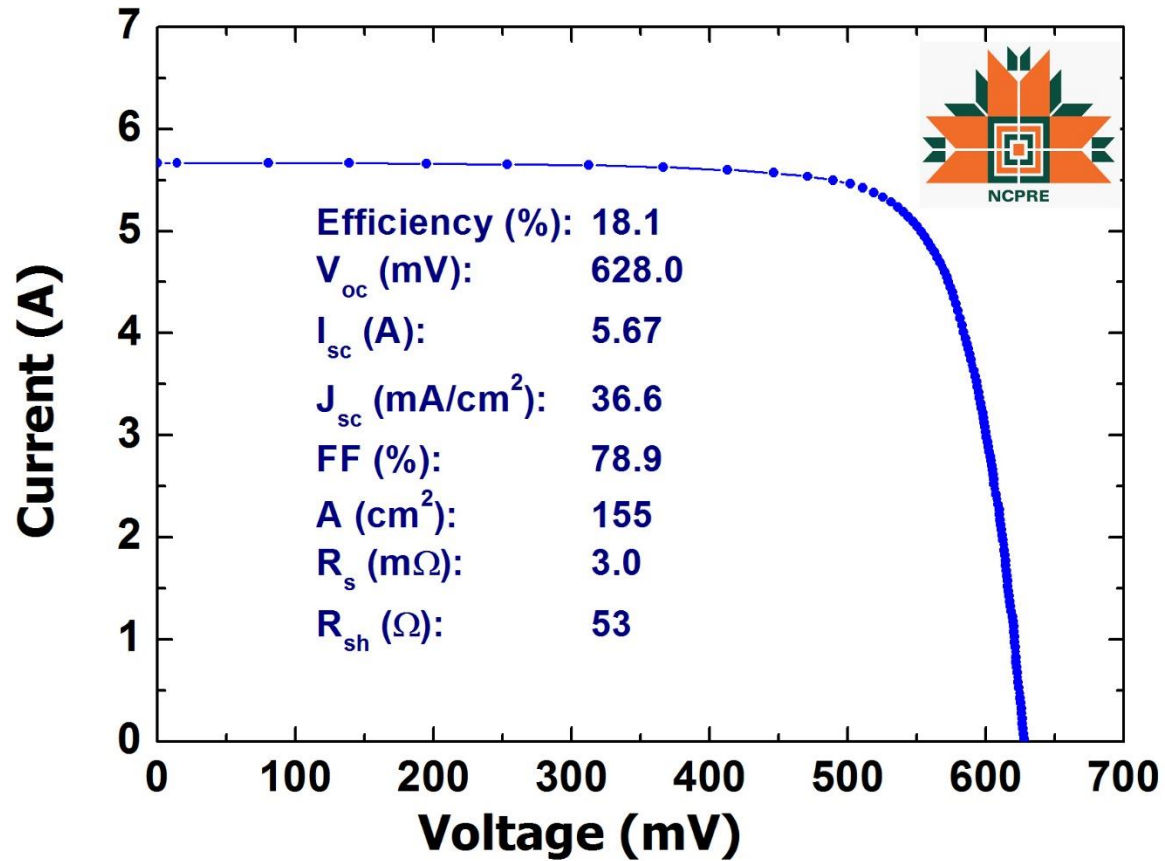
## Top side



## Rear side



# Solar Cells made at NCPRE



# NCPRE AI-BSF Process

	Process Flow	Fabrication Tools	Characterization Tools
1	Saw Damage Removal	Wet Bench	Zeta 3D Microscope
2	Alkali Texturization	Texturization Wet Bench	Zeta 3D Microscope, SEM, UV-Vis-NIR Spectrometer
3	Diffusion	Diffusion Furnace	SAN Four Probe, ECV Dopant Profiler*
4	PSG Removal & Thermal oxidation	Wet bench, Oxidation furnace	
5	Anti Reflective Coating	Plasma Enhanced Chemical Vapor Deposition (PECVD)	UV- Vis- NIR Spectrometer, Ellipsometer*
6	Plasma Edge Isolation	Reactive Plasma Etcher	
7	Contact Printing	Screen Printer & Drying Oven	Zeta 3D Microscope
8	Co-firing	Rapid Thermal Processing (RTP)	Zeta 3D Microscope

Sinton Lifetime Tester (up to contact printing),  
Photoluminescence



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# Post Cell Fabrication Characterization, Modeling and Special Characterizations

## Electrical and optical characterizations:

- Dark & Illuminated Current Voltage
- Quantum Efficiency
- Electroluminescence (EL)
- Light Beam Induced Current (LBIC) \*
- Lock-in Thermography\*

## Modeling:

- Sentaurus TCAD
- Griddler
- PC1D

## Loss analysis:

- Loss analysis to quantify different types of losses for targeted process optimization

## Special Characterizations:

- TEM, XPS, UPS, XRD, ICP-MS, ICP-AES, EDAX, FTIR, Raman Spectroscopy

\*Under procurement



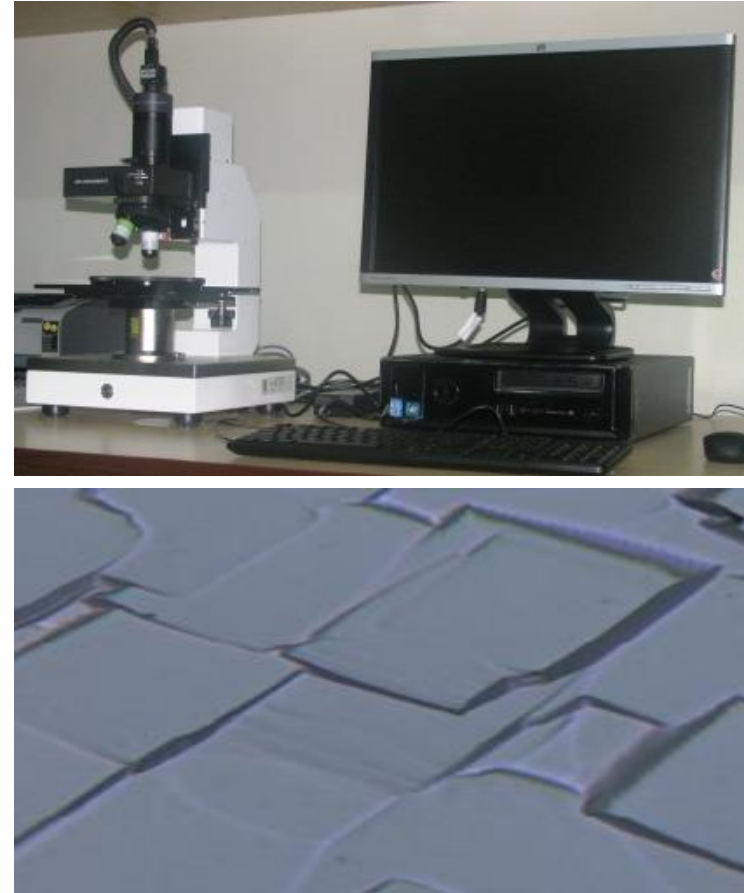
# Saw Damage Removal (SDR)

*SDR Wet Bench\$*

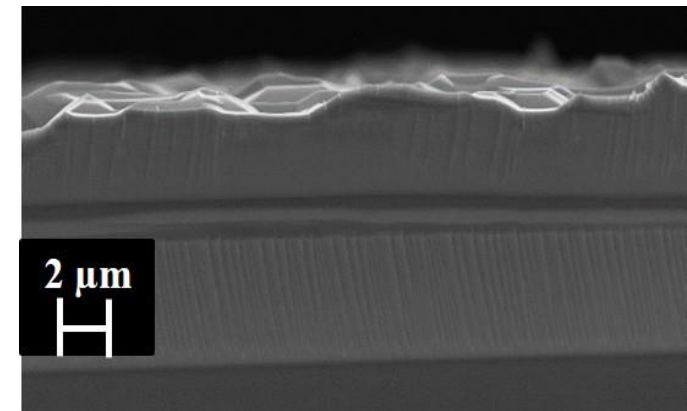


**\$ New one under procurement**

*Zeta 3 D (Zeta-20) Microscope*



*Scanning Electron Microscope  
(SEM)  
(EVO 18 Carl Zeiss with EDX)*



# Alkali Texturization

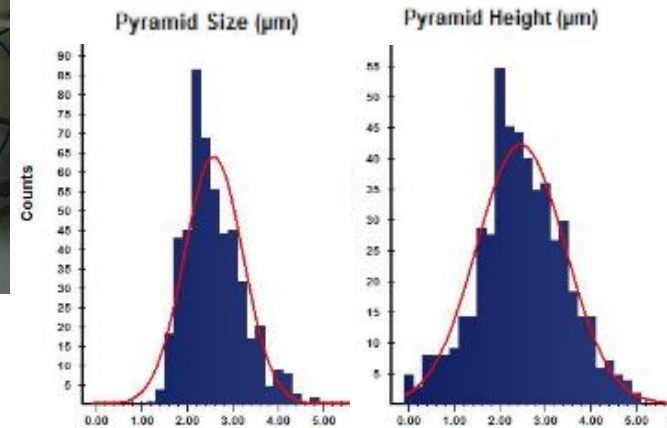
*Wet Benches* \$

Present ones

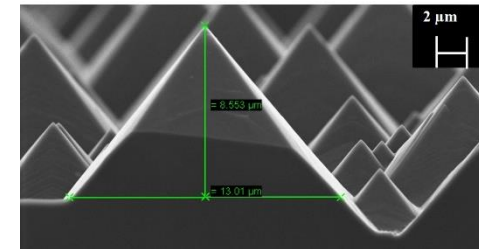


\$ New one under procurement

*Zeta 3 D Microscope*

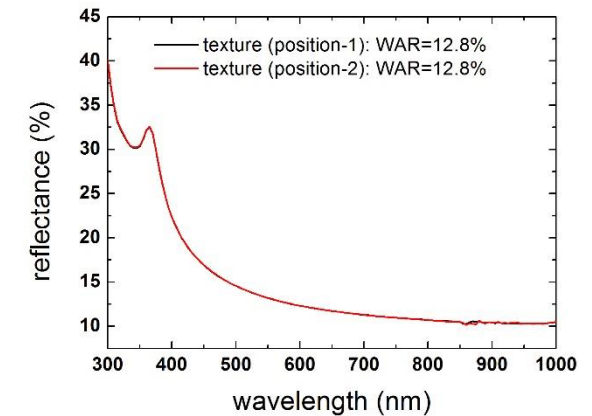


*SEM*



Elem- ents	At. concentration (%)	
	Existing process	Modified process
Na	0.21	0.04
K	0.05	0.00
Cl	0.17	0.08

*UV-Vis NIR Spectrometer  
(Lambda 950 Perkin Elmer)*



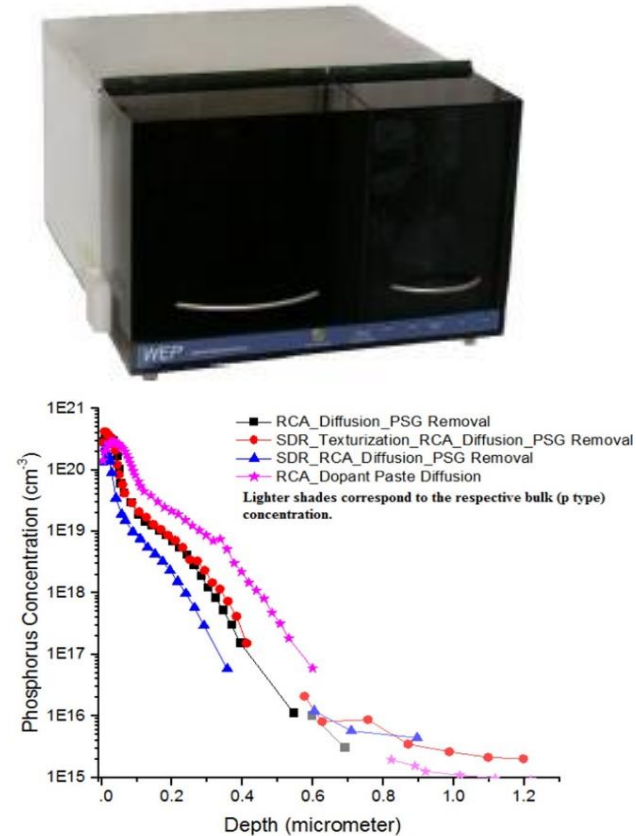


# Diffusion

*Diffusion Furnace  
(ProTemp)*

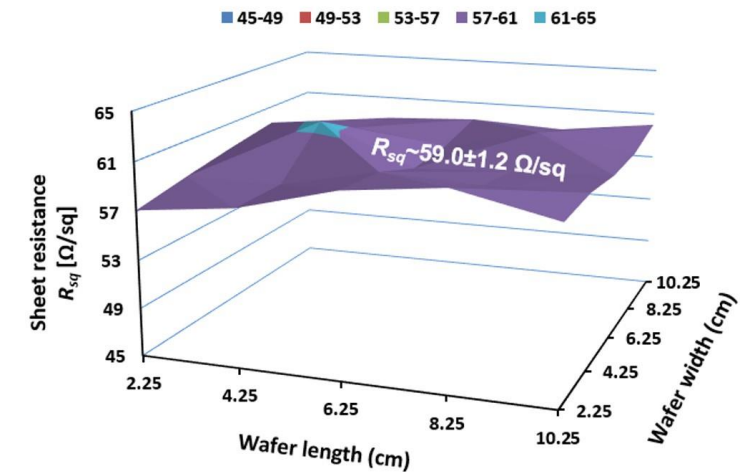


*ECV Profiler \**



ECV measurement done on NCPRE sample by potential supplier.

*Four Probe System  
(Keithley system with Jandel probe)*



# PSG Removal & Oxidation

*Wet Bench*

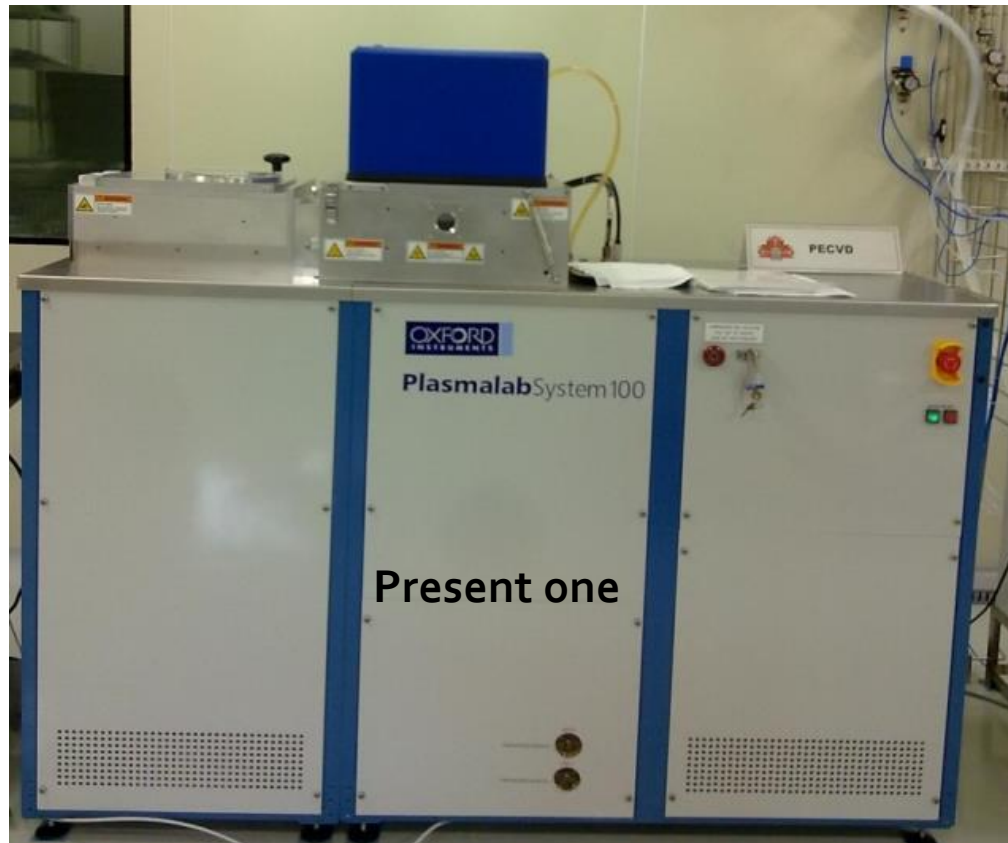


*Oxidation Furnace  
(ProTemp)*



# Anti Reflective Coating

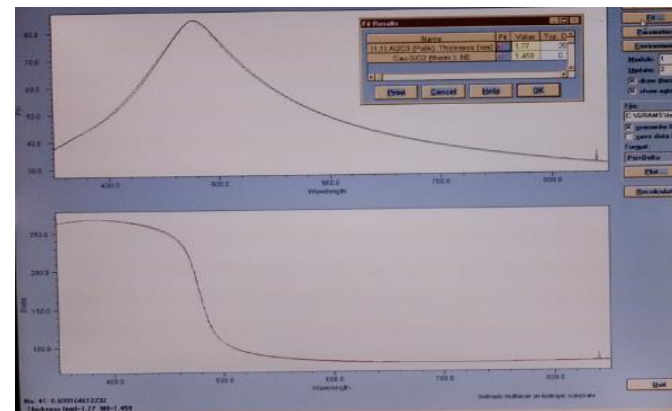
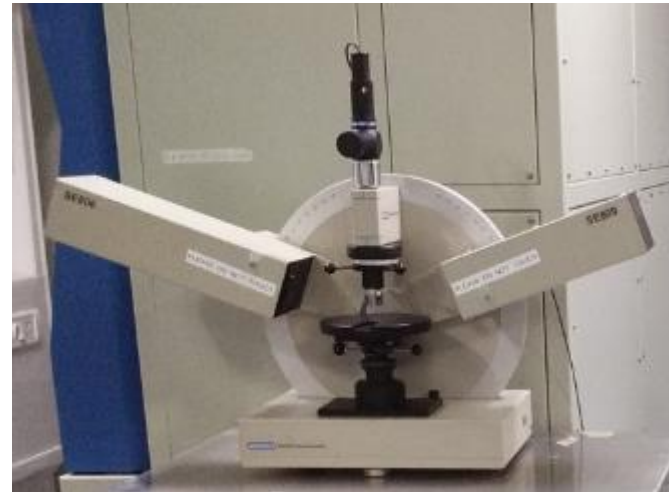
*PECVD System<sup>\$</sup>*  
*(PlasmaLab 100, Oxford Instr.)*



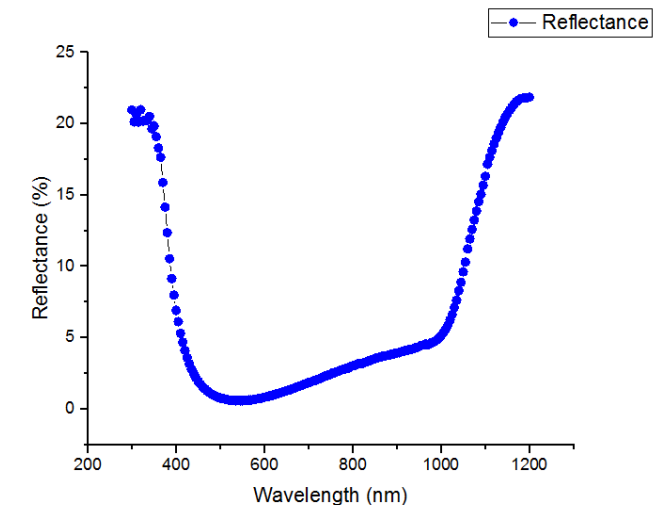
Present one

**\$ New one under procurement**

*Ellipsometer \**



*UV VIS NIR Spectrometer*



\* Under the process of procurement for textured samples.

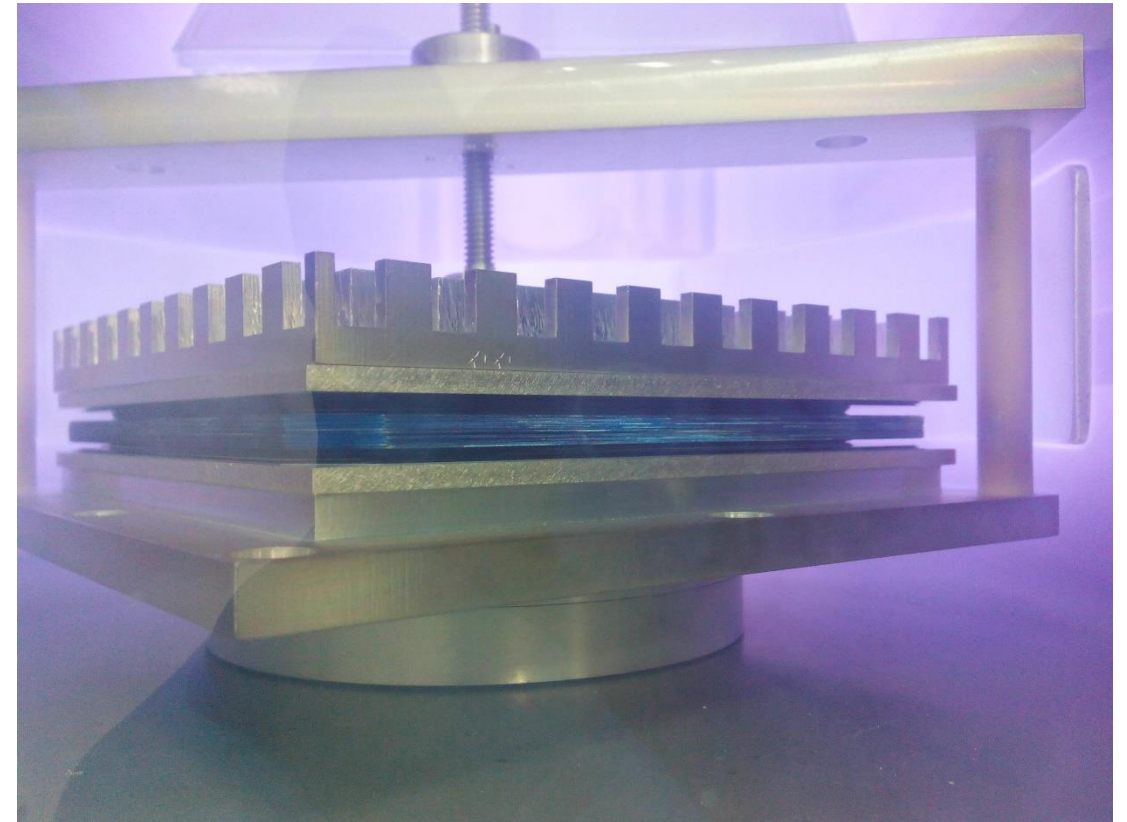


# Plasma Edge Isolation

## *Reactive Plasma Etcher¶ (NT-2, BEST EQ)*



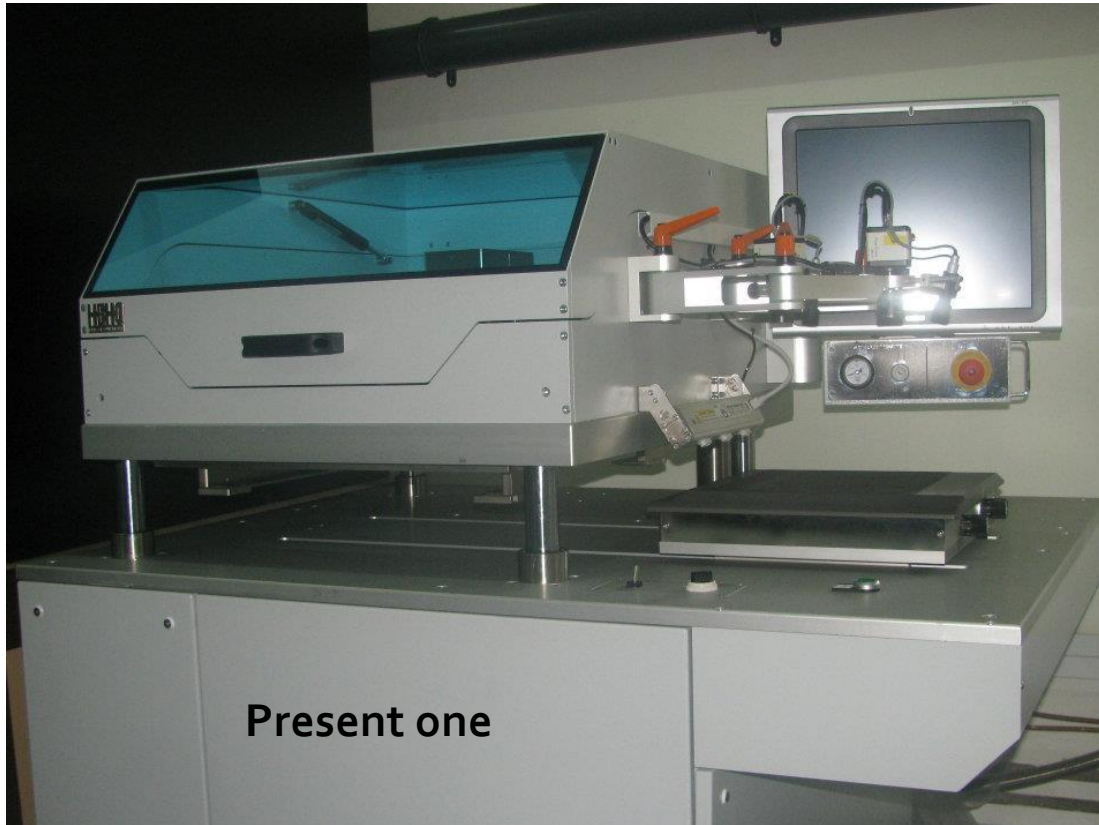
## *Coin stack arrangement of cells inside the system*



¶ alternate chemical process under planning

# Contact Printing

*Screen Printer<sup>\$</sup>  
(P-200S, Haikutech, Netherlands)*



Present one

**\$ New one under procurement**

*Top Contact Printed Wafers*





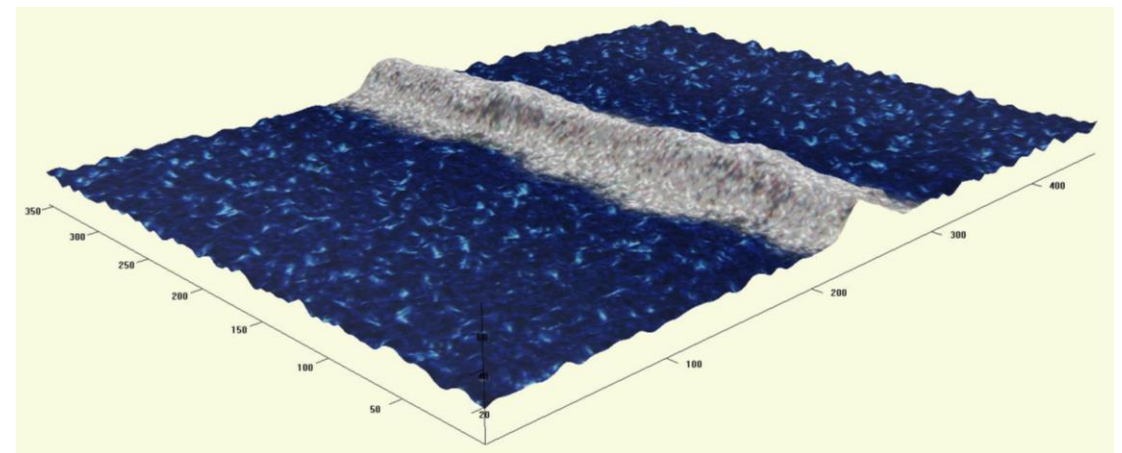
## Co- firing

### *Rapid Thermal Processing Tool \$ (AW 610, Allwyn21 Corp)*

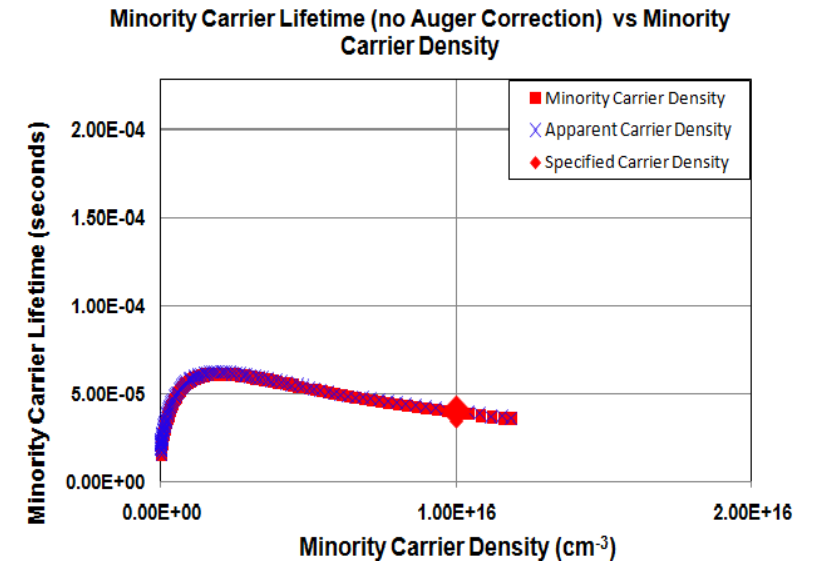
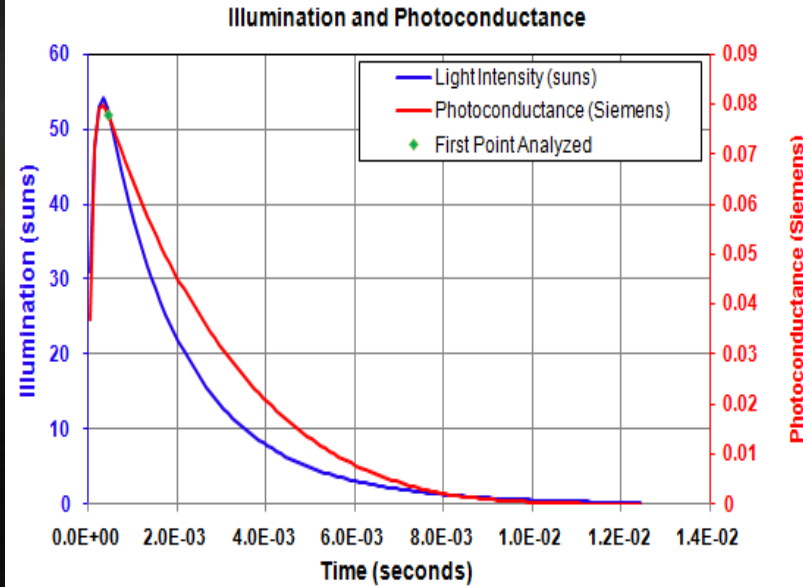


**\$ New belt furnace under procurement**

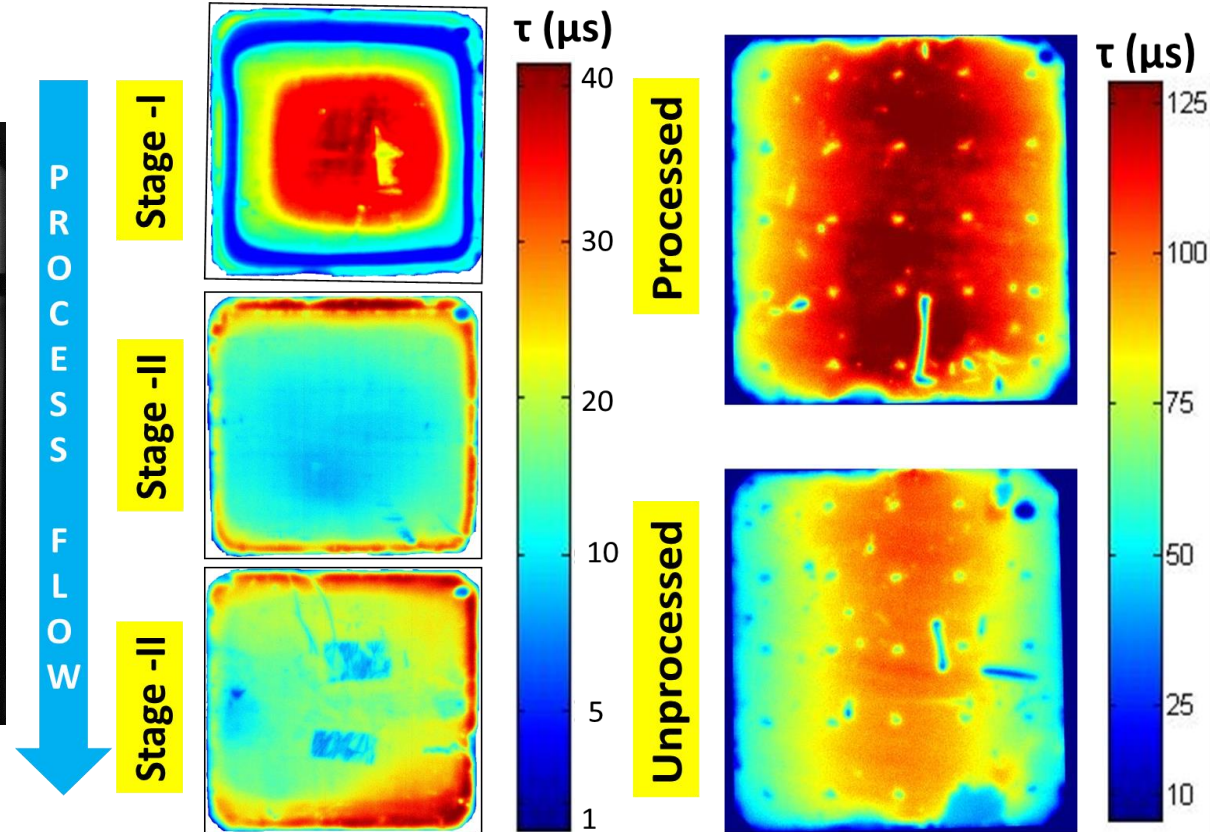
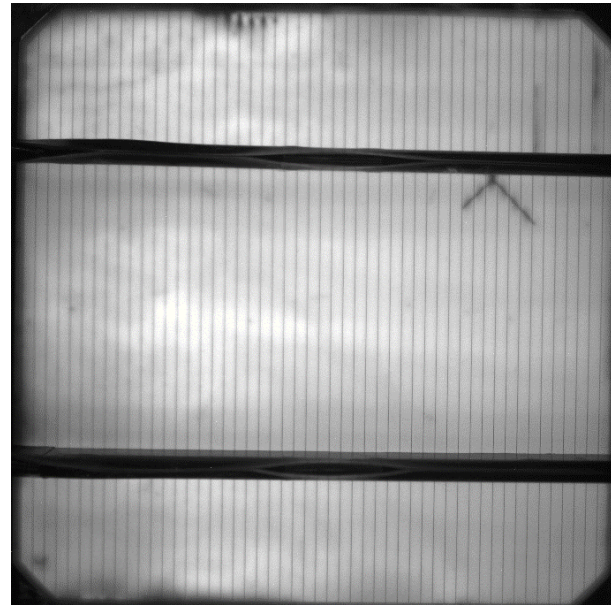
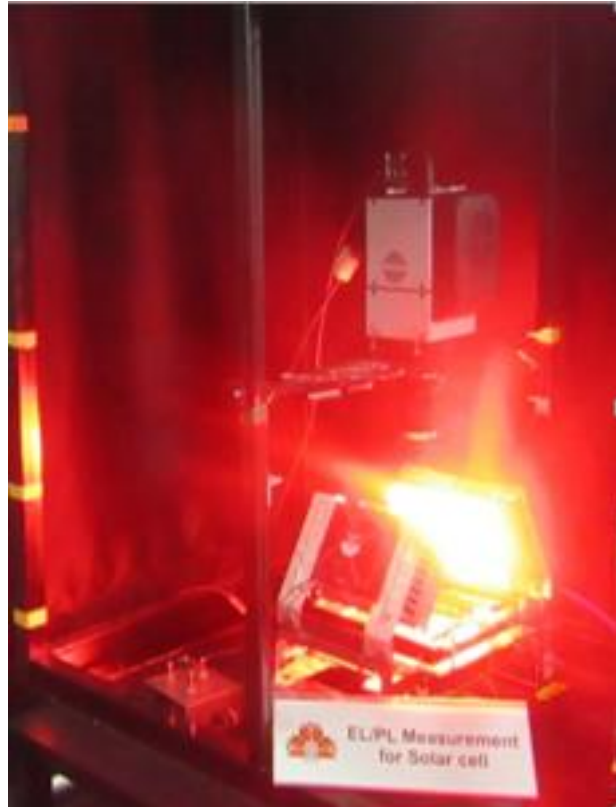
### *Zeta 3 D Microscope*



# Other In-line characterizations during fabrication – Lifetime Tester (Sinton WCT-120)



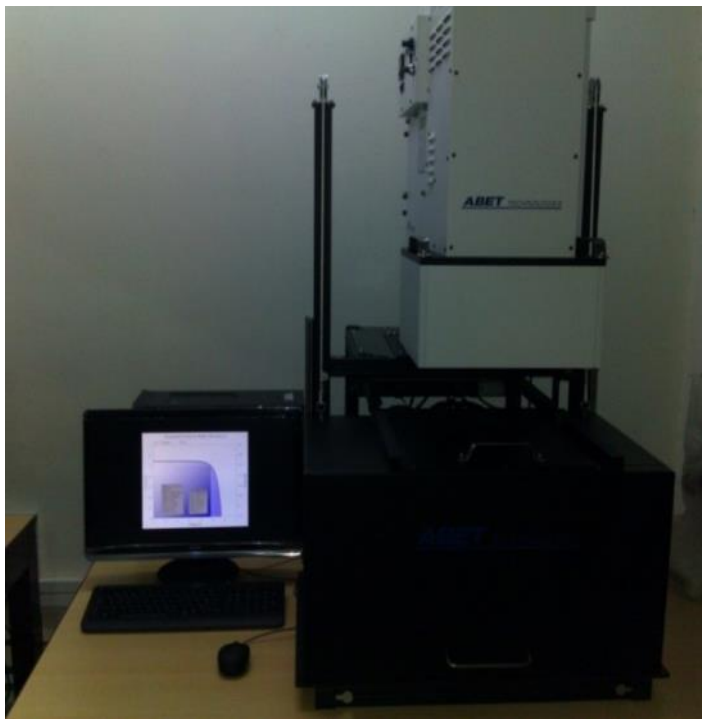
# Other In-line characterizations during fabrication- Photoluminescence (Developed at NCPRE)



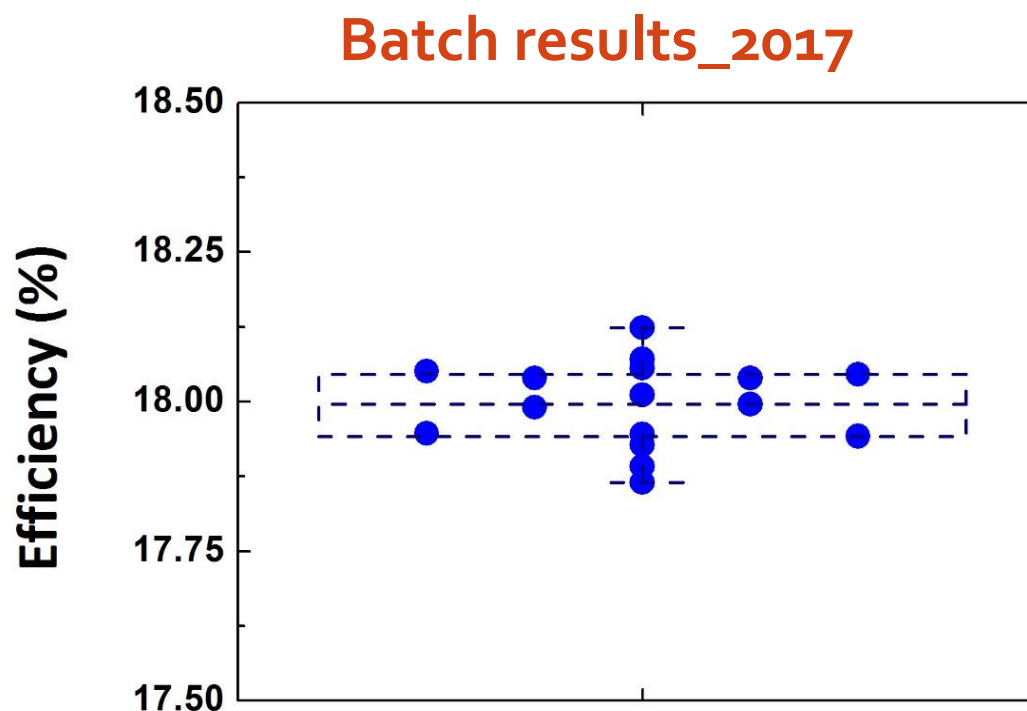


# Post Cell Characterization – Current – Voltage Measurements

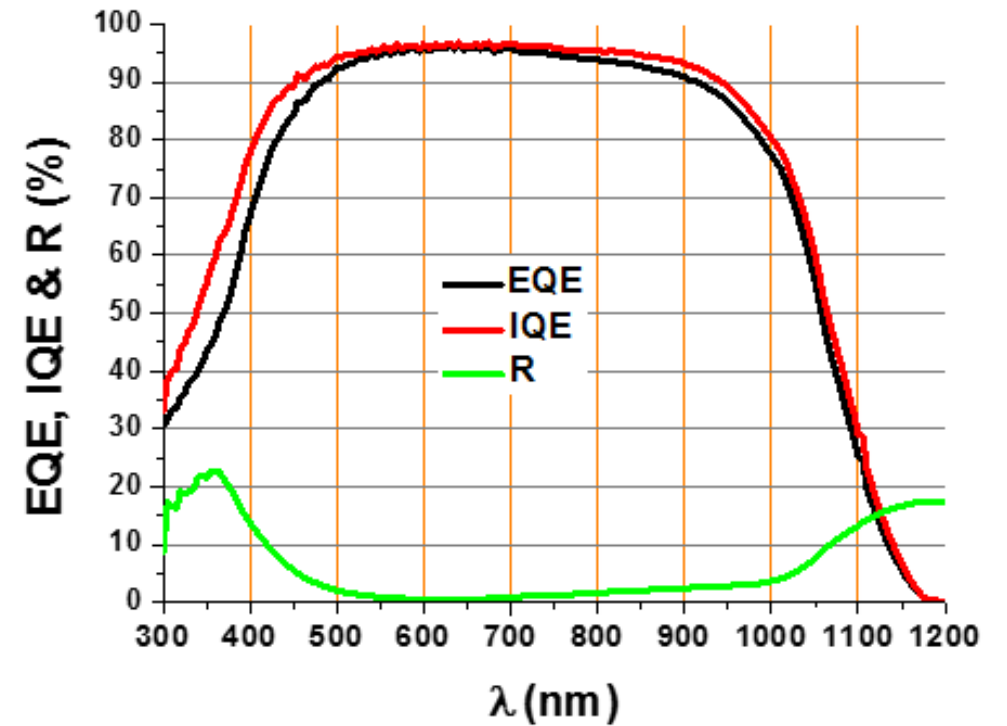
*Class AAA Solar Simulator  
(SUN 3000, ABETech.)*



*Sun's Voc Measurement  
(Sinton WCT-120)*

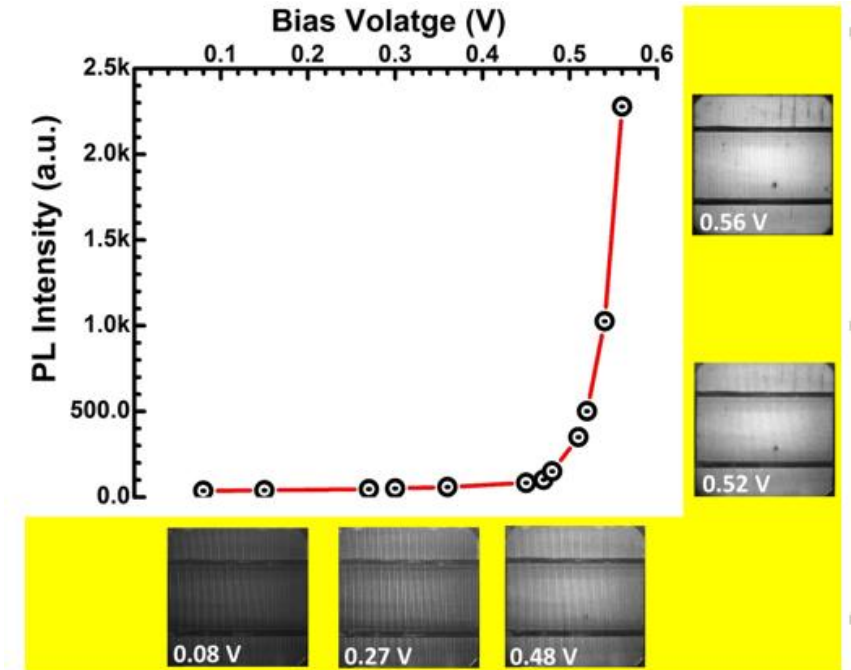
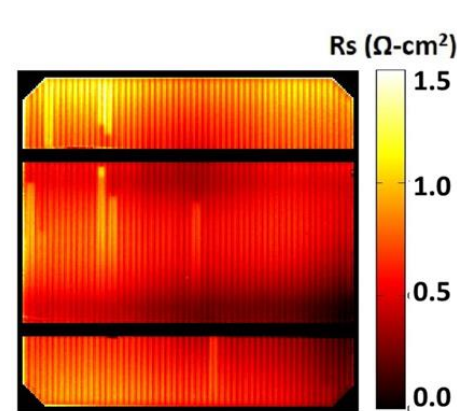
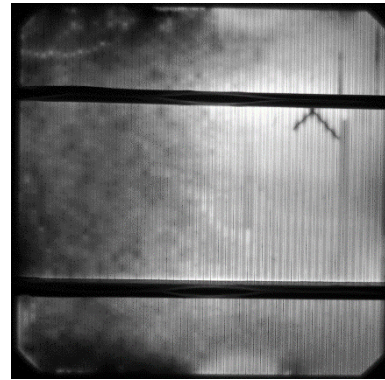
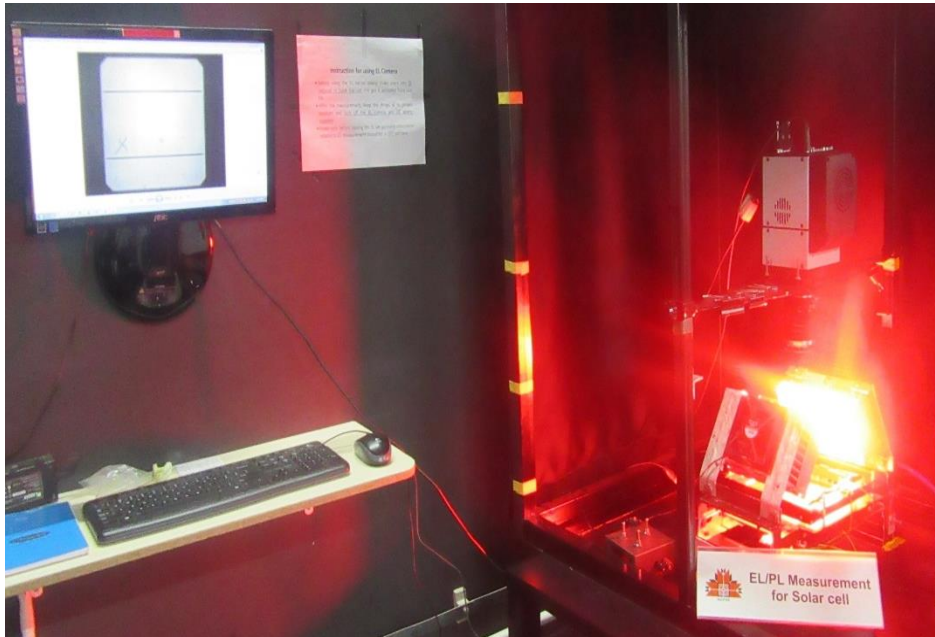


# Post Cell Characterization – Quantum Efficiency Measurement (Bentham PVE 300)



# Post Cell Characterization – Electro and Photo Luminescence (Developed at NCPRE)

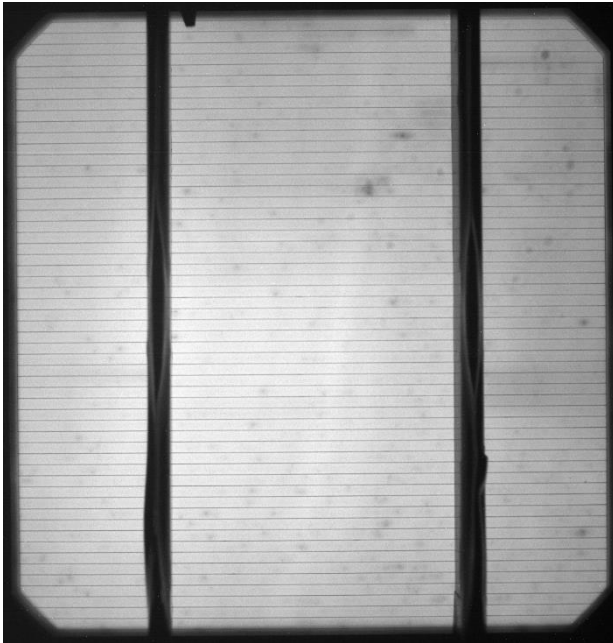
## Luminescence Measurement Setup



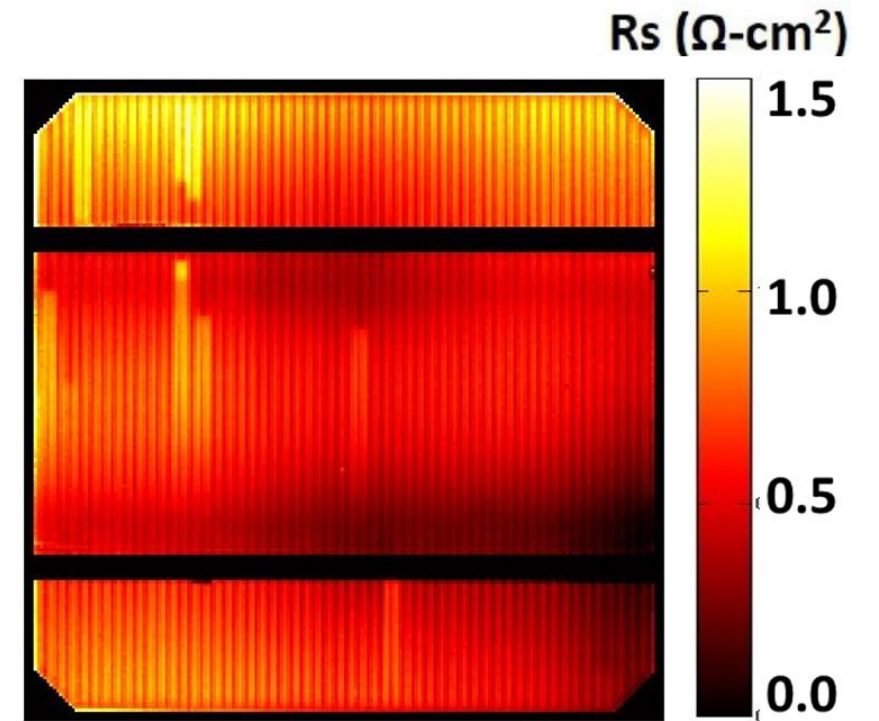
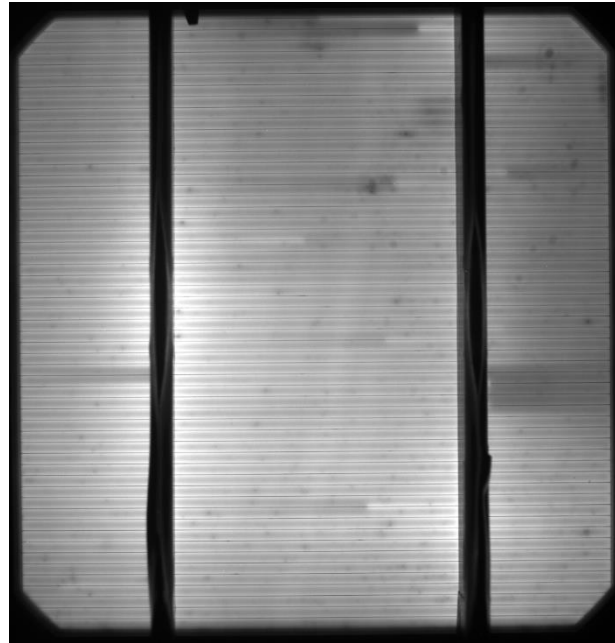


## Post Cell Characterization – Luminescence contd..

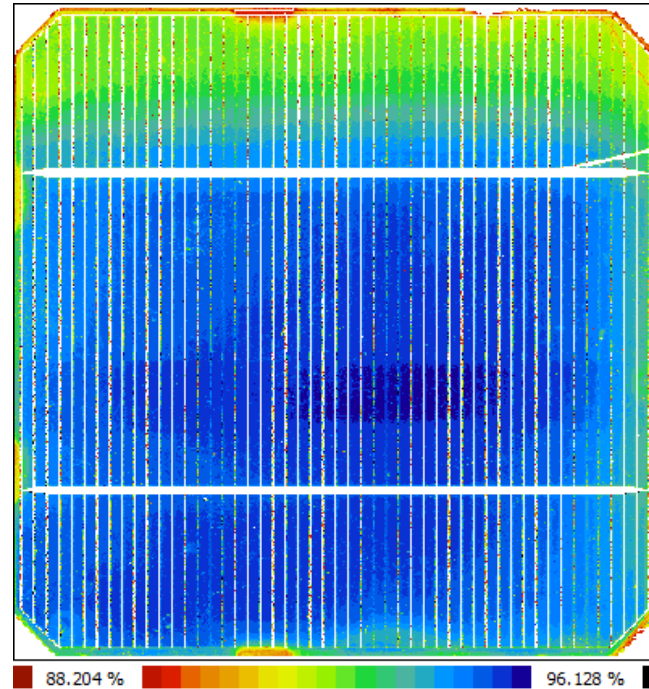
*EL for shunt detection*



*EL for series resistance detection*

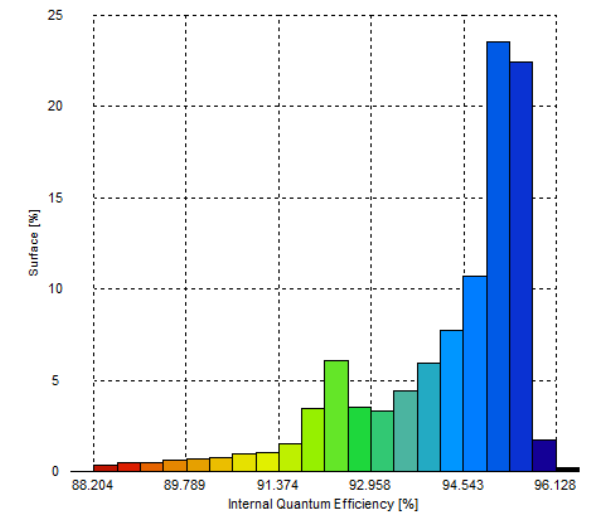


# Post Cell Characterization – Light Beam Induced Current Measurements \*



# Measurement done on NCPRE sample by potential supplier.

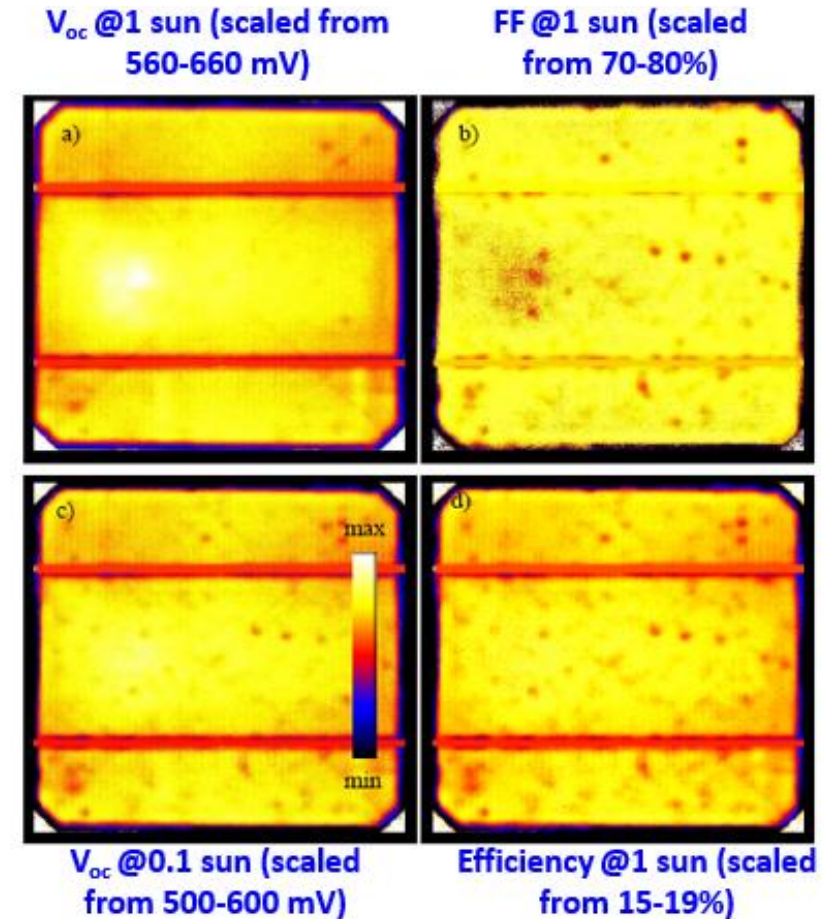
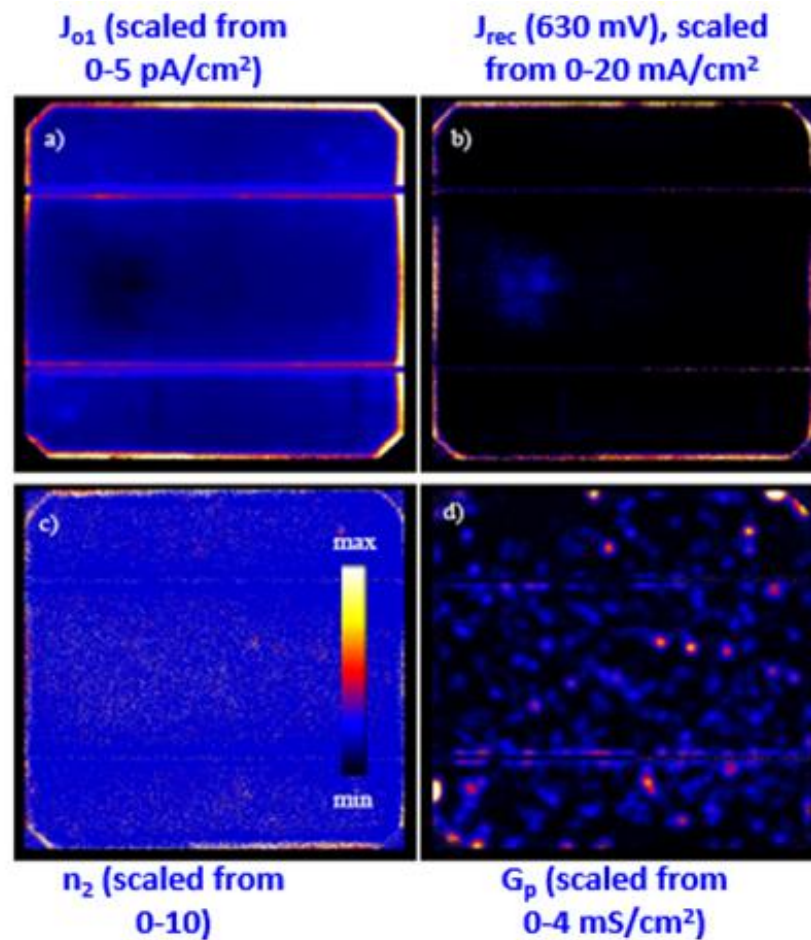
Internal Quantum Efficiency [%]			
Average:	94.242	Minimum:	88.204
Median:	94.406	Maximum:	118.05
Deviation:	1.6006		



\* Under the process of procurement.



# Post Cell Characterization – Lock In Thermography \*

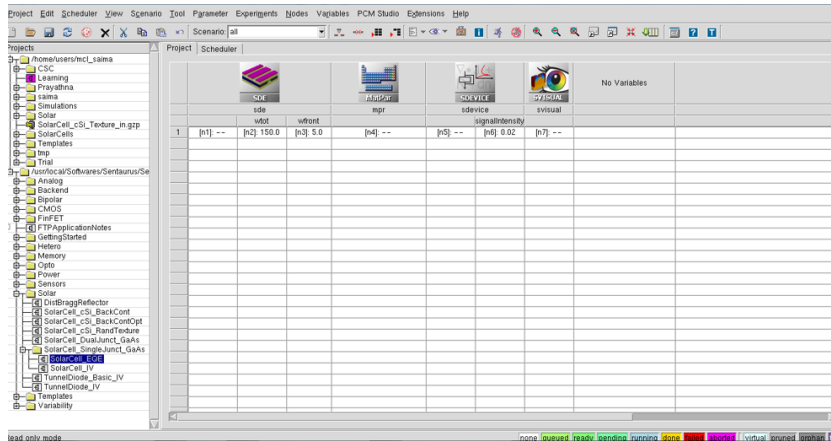


# Measurement done on NCPRE sample by Dr. Breitenstein, MaxPlank Institute Halle, Germany

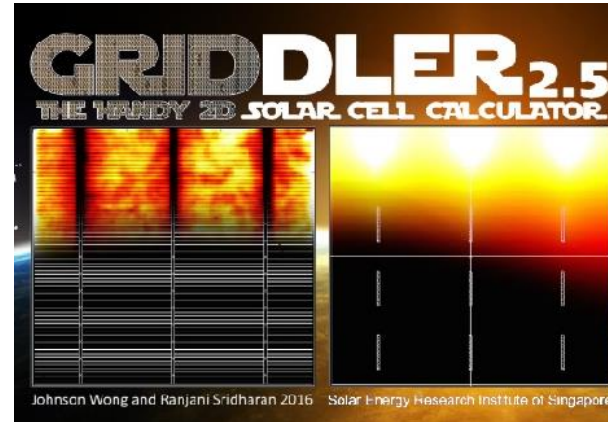
\* Under the process of procurement.

# Modeling

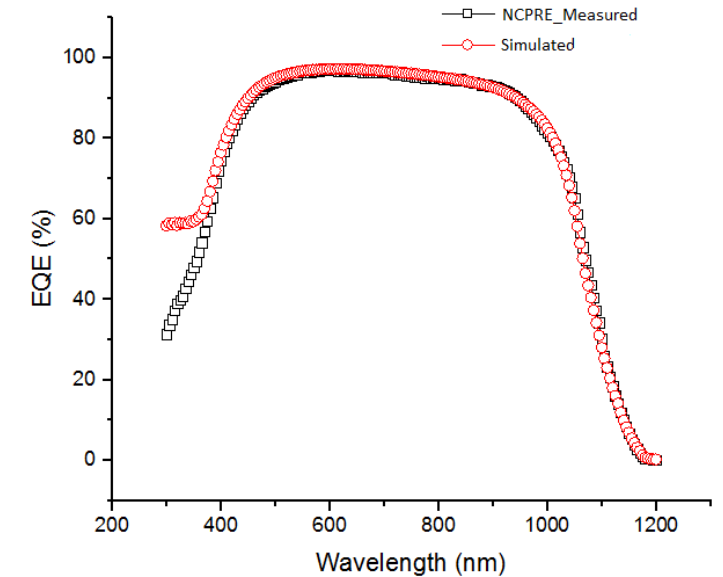
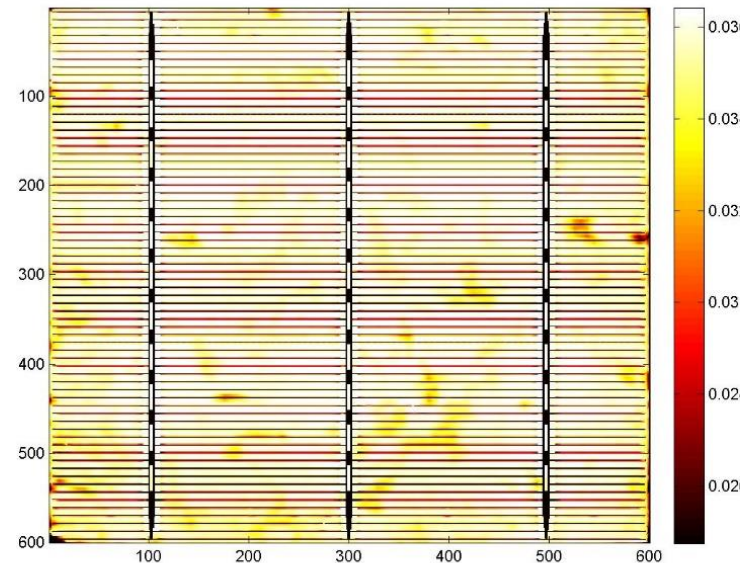
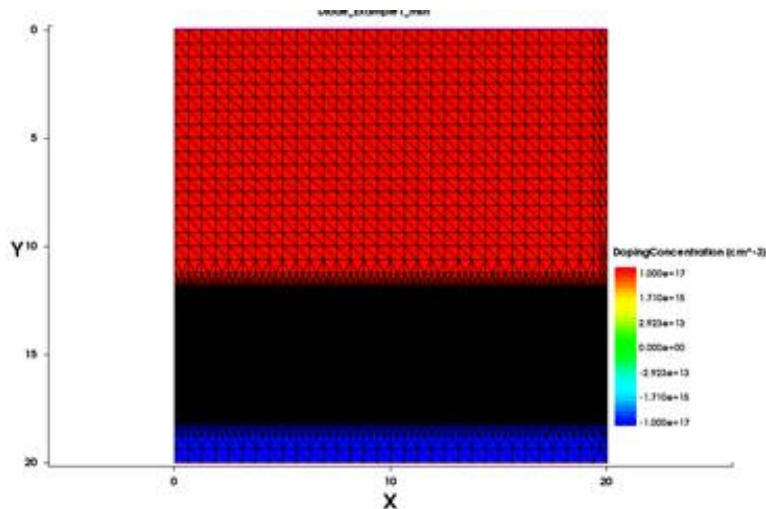
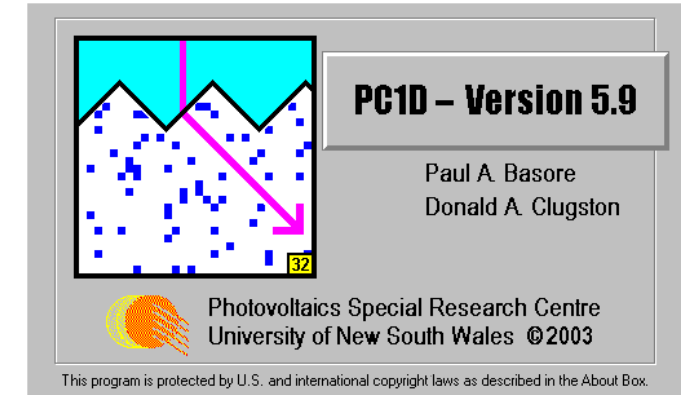
## SentaurusTCAD



## Griddler



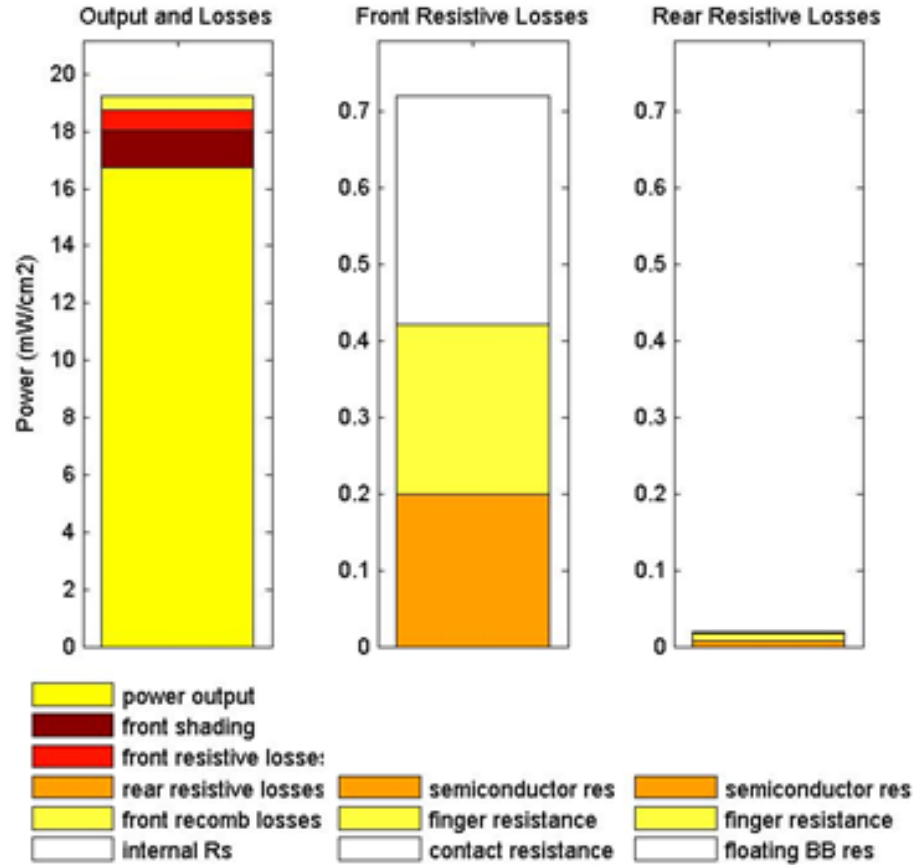
## PC 1D



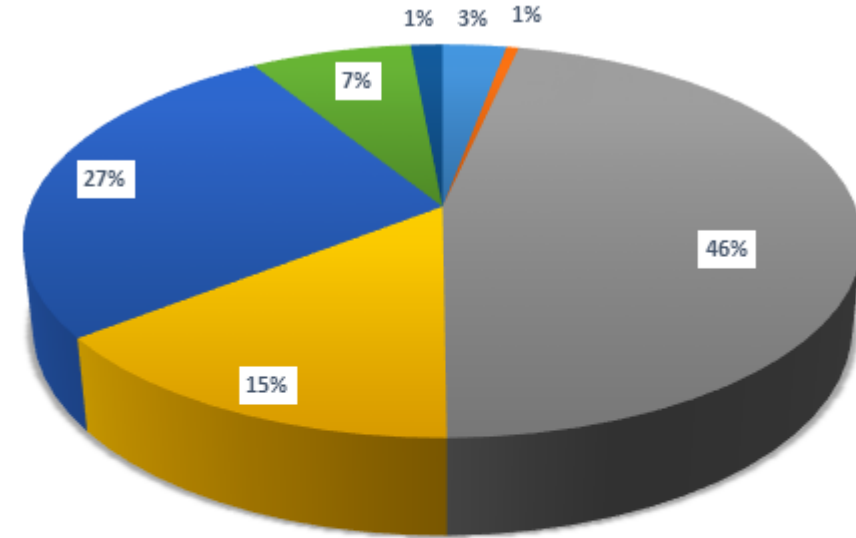
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-Supported by Ministry of New and Renewable Energy, Government of India

# Loss Analysis

## Griddler



## Analytical Power Loss Analysis



- Series Resistance
- Non-perfect IQE up to  $\lambda \sim 1200$  nm
- Metal Shading
- Front Surface Escape
- Shunt Resistance
- Forward biased current at MPP
- Front Surface Reflection (Active Area)

# What can NCPRE offer the silicon PV cell manufacturers and supply chain?

## ❑ Process development

- Engagement with one cell manufacturer on advanced texturization
- Engagement with an Indian chemical company for development of metallization
- In discussions with two international players on junction technologies

## ❑ Extensive wafer level characterization and analysis

- Engagements with 3 cell manufacturers in the country on loss analysis

## ❑ Joint development of advanced cell technologies

### ➤ Phase 2 commitments

- Al-BSF cells with copper front metallization
- PERC cells with 20% efficiency
- IBC cells with 22% efficiency
- Carrier selective contact cells with 18% efficiency

## ❑ Joint internship programs

- M. Tech students spent part of their time at cell manufacturer to pick up development and manufacturing related topics for co-development

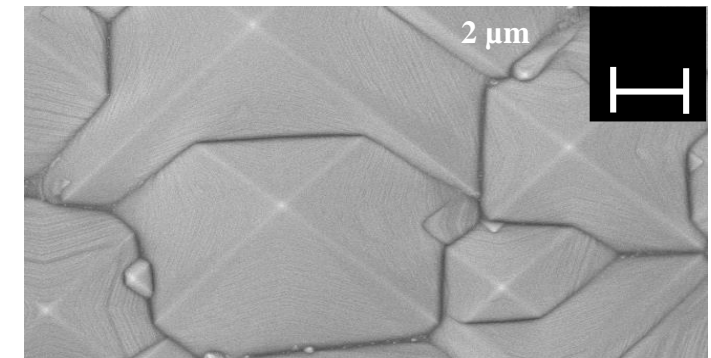
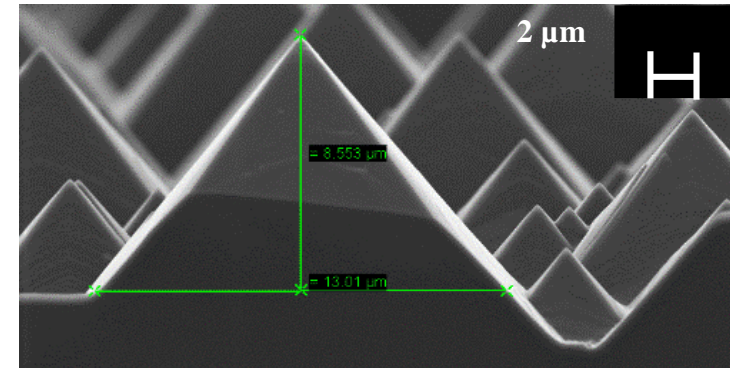


# Technology Ready for Industrial Evaluation

## IPA-free texturization process for monocrystalline Si wafers

Indian patent application number 201621039056

- A new industrial alkaline texturization process of mono-Si wafer by using an IPA-free commercial additive is developed
  - ✓ Clean SDR and pyramidal surfaces
  - ✓ Low WAR values
  - ✓ Good and uniform pyramid formation
  - ✓ The process permits repeated use of the SDR and neutralization solutions for multiple batches
  - ✓ Highly suitable as an industrial process with high throughput and low-cost involved





## The Team

- **Faculty members:** Prof. B. M. Arora, Prof. K. L. Narsimhan, Prof. Balasubramiam Kavaipatti, Prof. Saurabh Lodha, Prof. Manoj Neergat, Prof. Anil Kottantharayil
- **Senior Research Staff:** Dr. Prabir Basu, Dr. Ashok Sharma, Dr. Archana Sinha, Dr. Diksha Makwani
- **Ph. D. Students:** Amruta Joshi, Kalaivani, Tarun Yadav, Saima Cherukat, Dhiman Nag, Sreejith KP, Astha Tyagi, Suren Patwardhan, Divya Priyadarshini, Raja Sekhar Baddula
- **M. Tech students:** Pradeep Padmanabhan
- **Research support staff:** Sandeep Kumbhar, Abhishek Bhattacharya, Suchishmita Banerjee, Prashant Shinde, Guru Burkul